

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT														
NATURE OF CONVEYANCE:	ASSIGNMENT														
CONVEYING PARTY DATA															
<table border="1"><thead><tr><th>Name</th><th>Execution Date</th></tr></thead><tbody><tr><td>Shinichi NAGAHAMA</td><td>07/26/2003</td></tr><tr><td>Masahiko SANO</td><td>07/26/2003</td></tr><tr><td>Tomoya YANAMOTO</td><td>07/26/2003</td></tr><tr><td>Keiji SAKAMOTO</td><td>07/26/2003</td></tr><tr><td>Masashi YAMAMOTO</td><td>07/26/2003</td></tr><tr><td>Daisuke MORITA</td><td>07/26/2003</td></tr></tbody></table>		Name	Execution Date	Shinichi NAGAHAMA	07/26/2003	Masahiko SANO	07/26/2003	Tomoya YANAMOTO	07/26/2003	Keiji SAKAMOTO	07/26/2003	Masashi YAMAMOTO	07/26/2003	Daisuke MORITA	07/26/2003
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<table border="1"><tr><td>Name:</td><td>NICHIA CORPORATION</td></tr><tr><td>Street Address:</td><td>491-100, Oka, Kaminaka-cho</td></tr><tr><td>City:</td><td>Anan-shi, Tokushima</td></tr><tr><td>State/Country:</td><td>JAPAN</td></tr><tr><td>Postal Code:</td><td>774-8601</td></tr></table>		Name:	NICHIA CORPORATION	Street Address:	491-100, Oka, Kaminaka-cho	City:	Anan-shi, Tokushima	State/Country:	JAPAN	Postal Code:	774-8601				
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PROPERTY NUMBERS Total: 1															
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CORRESPONDENCE DATA															
Fax Number: (703)760-7777 <i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>															
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ATTORNEY DOCKET NUMBER:	204552029200														

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PATENT
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NAME OF SUBMITTER:

Takamitsu Fujii

Total Attachments: 2

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ASSIGNMENT

For good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, the undersigned hereby assign(s), transfer(s) and set(s) over to:

NICHIA CORPORATION

491-100, Oka, Kaminaka-cho,
Anan-shi, Tokushima 774-8601 Japan

(hereinafter designated as the "ASSIGNEE"), its successors and assigns, the entire right, title, and interest for the United States in the invention, and all applications for patent and any Letters Patent which may be granted therefor, including said application, and all United States Letters Patent which may be granted thereof, and all divisions, reissues, continuations and extensions thereof, the said interest being the entire ownership of said Letters Patent when granted to be held by said ASSIGNEE, its successors, assigns or their legal representatives, to the full end of the term for which said Letters Patent may be granted, as fully and entirely as the same would have been and enjoyed by Assignor(s) if this assignment had not been made, the application being known by the title:

NITRIDE SEMICONDUCTOR DEVICE COMPRISING BONDED SUBSTRATE AND FABRICATION METHOD OF THE SAME

Attorney Docket No.: 204552029200

for which the undersigned has/have executed an application for patent in the United States of America on the same day herewith. Where this instrument is not filed concurrently with the application, the following identifying information may be added after execution:

Serial No.: 10/614,342

Filing Date: July 8, 2003

1. The undersigned hereby agree(s) to sign and execute any further documents and instruments which may be necessary, lawful and proper in the prosecution of said above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reexamination or reissue application or in any amendments, extension of interference proceedings, or otherwise to secure the title thereto to the ASSIGNEE.
2. The undersigned agree(s) to execute all papers and documents and perform any act which may be necessary in connection with claims or provisions of the International Convention for Protection of Industrial Property of similar agreements.

3. The undersigned agree(s) to perform all affirmative acts which may be necessary to obtain a grant of a valid United States patent to the ASSIGNEE.

4. The undersigned hereby authorize(s) and request(s) the Commissioner of Patents in the United States to issue any and all Letters Patent resulting from said application or any division or divisions or continuing applications thereof to the said ASSIGNEE.

5. The undersigned hereby grant(s) to the firm of Morrison & Foerster LLP the power to insert on this assignment any further identification which may be necessary or desirable in order to comply with the rules of the United States Patent and Trademark Office for recordation of this document.

IN WITNESS WHEREBY, executed by the undersigned on the date(s) opposite the undersigned name(s).

July 26, 2003

Date

Shinichi Nagahama

Typed Name: Shinichi NAGAHAMA

July 26, 2003

Date

Masahiko Sano

Typed Name: Masahiko SANO

July 26, 2003

Date

Tomoya Yamamoto

Typed Name: Tomoya YANAMOTO

July 26, 2003

Date

Keiji Sakamoto

Typed Name: Keiji SAKAMOTO

July 26, 2003

Date

Masashi Yamamoto

Typed Name: Masashi YAMAMOTO

July 26, 2003

Date

Daisuke Morita

Typed Name: Daisuke MORITA